TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type (U-MOSVI)

# SSM3J327F

# Power Management Switch Applications

• 1.5-V drive

• Low ON-resistance:  $R_{DS(ON)} = 242 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.5 V)}$ 

 $R_{DS(ON)} = 170 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.8 V)}$ 

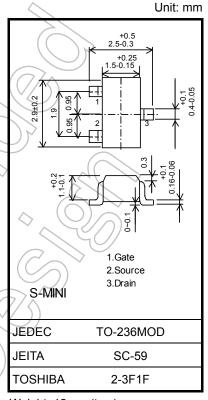
 $R_{DS(ON)} = 125 \text{ m}\Omega \text{ (max) (@V_{GS} = -2.5 V)}$ 

 $R_{DS(ON)} = 95 \text{ m}\Omega \text{ (max) } (@V_{GS} = -4.5 \text{ V})$ 

# Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DSS</sub>	-20	V	
Gate-Source voltage		V <sub>GSS</sub>	± 8	$(\sqrt{y})$	
Drain current	DC	I <sub>D</sub> (Note 1)	-3.5	A	
	Pulse	I <sub>DP</sub> (Note 1)	-7.0		
Power dissipation		P <sub>D</sub> (Note 2)	600	mW	
		t = 1s	1200		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



Weight: 12 mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions","Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

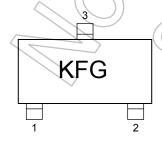
Note 1: The channel temperature should not exceed 150°C during use.

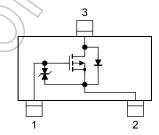
Note 2: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

### Marking (Top View)

#### **Equivalent Circuit**





#### **Electrical Characteristics (Ta = 25°C)**

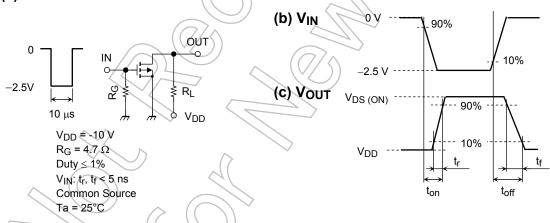
Chara	acteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit	
Drain-Source breakdown voltage		V <sub>(BR)DSS</sub>	I <sub>D</sub> = -1 mA, V <sub>GS</sub> = 0 V	-20	_	_	V	
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = 5 \text{ V}$ (Note 4)	-15	_	_	V	
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V	_	_	-1	μΑ	
Gate leakage curi	rent	I <sub>GSS</sub>	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	7/		±1	μА	
Gate threshold vo	ltage	V <sub>th</sub>	$V_{DS} = -3 \text{ V}, I_{D} = -1 \text{ mA}$	-0.3	1	-1.0	V	
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -3 \text{ V}, I_D = -1.0 \text{ A}$ (Note 3)	2.8	5.6	_	S	
Drain-source ON-resistance			$I_D = -1.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ (Note 3)		80.5	95	mΩ	
		D== (===	I <sub>D</sub> = -1.0 A, V <sub>GS</sub> = -2.5 V (Note 3)	V(—))	99.5	125		
		R <sub>DS</sub> (ON)	$I_D = -0.5 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note 3)		122	170		
			$I_D = -0.25 \text{ A}, V_{GS} = -1.5 \text{ V}$ (Note 3)	15	143	242		
Input capacitance		C <sub>iss</sub>	V 40V V 0V	<b>ソ</b> ー	290		pF	
Output capacitance		Coss	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V f = 1 MHz		44((	1		
Reverse transfer capacitance		C <sub>rss</sub>	T - T IVII IZ		32			
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD}$ = -10 V, $I_{D}$ = -0.5 A $V_{GS}$ = 0 to -2.5 V, $R_{G}$ = 4.7 $\Omega$		12.0	$\rightarrow$	ns	
	Turn-off time	t <sub>off</sub>		$\Diamond$	46.2	7		
Total Gate Charge		Qg		_<	4.6	//—	nC	
Gate-Source Charge		Q <sub>gs</sub>	$V_{DD} = -10 \text{ V}, I_{DS} = -3.5 \text{ A},$ $V_{GS} = -4.5 \text{ V}$		3.4			
Gate-Drain Charge		Q <sub>gd</sub>	VGST. V		) 1.2	_		
Drain-Source forward voltage V <sub>I</sub>		V <sub>DSF</sub>	I <sub>D</sub> = 3.5 A, V <sub>GS</sub> = 0 V (Note 3)	5.2	0.96	1.2	V	

Note 3: Pulse test

Note4: If a forward bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

# **Switching Time Test Circuit**





#### **Notice on Usage**

Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current (I<sub>D</sub>) to be low (-1 mA for the SSM3J327F). Then, for normal switching operation,  $V_{GS(on)}$  must be higher than  $V_{th}$ , and  $V_{GS(off)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ .

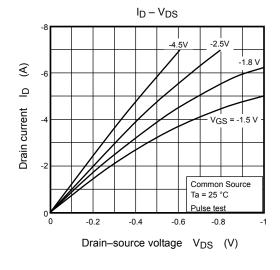
Take this into consideration when using the device.

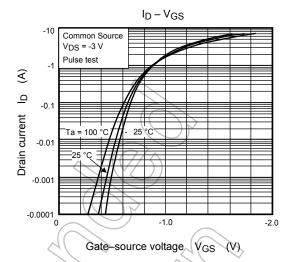
#### **Handling Precaution**

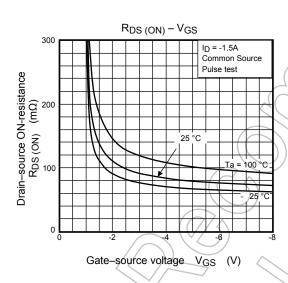
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

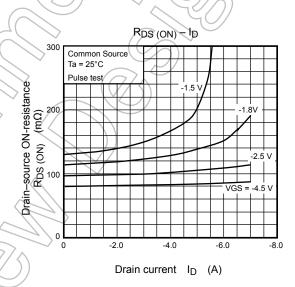
Thermal resistance  $R_{th}$  (ch-a) and power dissipation  $P_D$  vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration

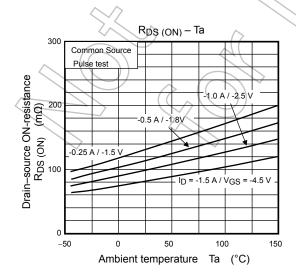
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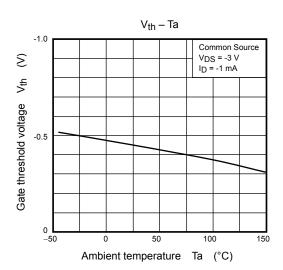


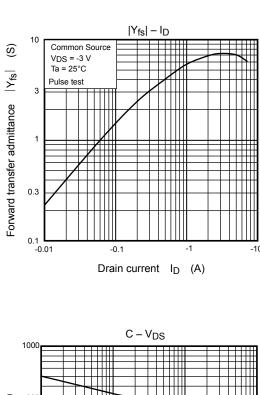


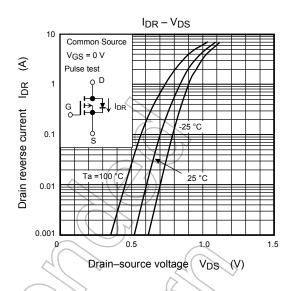


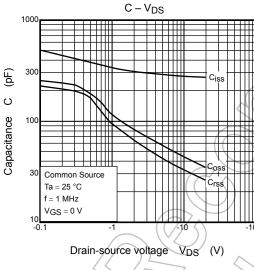


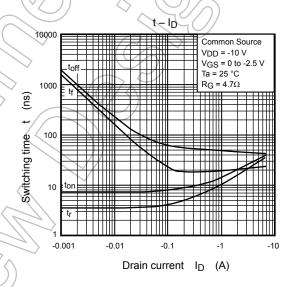


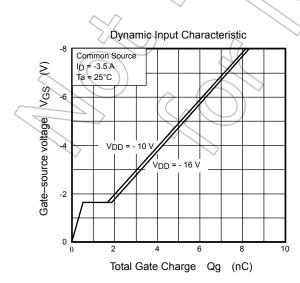




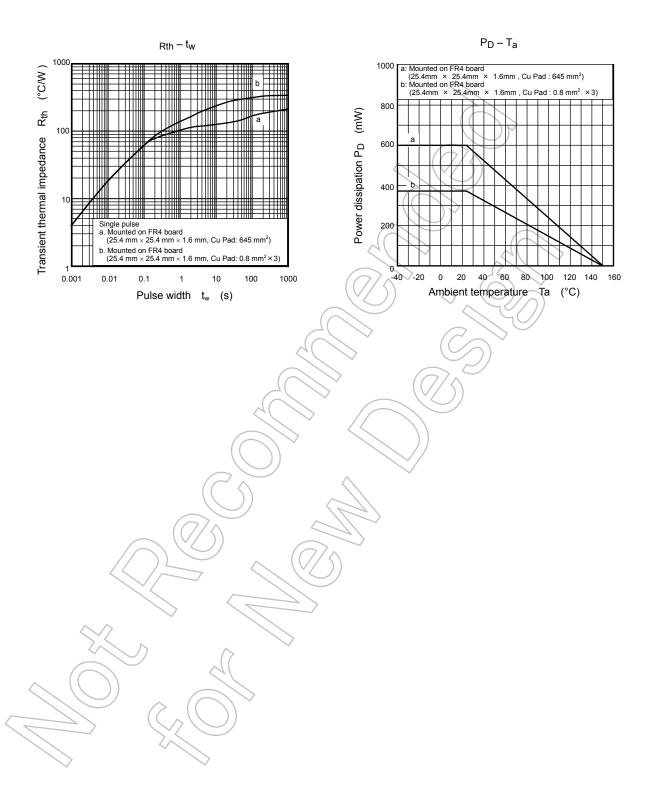








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